The product information in this catalog is for reference only. Please request the Engineering Drawing for the most current and accurate design information. All non-RoHS products have been discontinued, or will be discontinued soon. Please check the products status on the Hirose website RoHS search at www.hirose-connectors.com, or contact your Hirose sales representative.

High Density FPC Connector (0.3mm/0.4mm/0.5mm Pitch)

FH16 Series



Features

1. High Density FPC Connector

The FH16 series is a fine pitch, zero insertion force (ZIF), right angle, bottom contact, connector compatible with flexible printed circuits (FPC) with a pitch of 0.3mm, 0.4mm, and 0.5mm and a recommended thickness of 0.293mm for single-sided or 0.297mm for double-sided. The FH16 provides a higher pin count given the same amount of board space than other manufacturers of similar product. With a large selection in pin density, the FH16 series greatly improves design flexibility.

- FH16 : 0.3mm pitch 60, 80, and 90 contacts
- FH16M : 0.4mm pitch 80 and 96 contacts
- FH16H : 0.5mm pitch 50 contacts
- FH16P : 0.5mm pitch 64 contacts

2. Easy mounting on PCB

FH16 supports 0.3mm pitch cable but only requires a 0.6mm pitch pad layout on the PCB. The FH16's staggered pin design allows the mounting lead area to be twice as wide as the FPC contact area making it easier to place the connector on the board given the fine pitch of the contacts.

3. User Friendly Flip-Lock Design

The flip-lock (one-touch rotating type) ZIF structure secures the FPC connection with a single and light force. This design helps simplify assembly and repair work. When locking the FPC, the audible click assures the assembly worker of a steady FPC connection resulting in improved customer service.

4. Prevents FPC from escape and oblique mating

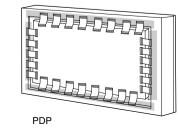
The FH16 series with its recommended FPC dimensions prevents the FPC from escape and oblique mating thereby securing a steady connection.

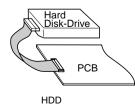
5. Compatible with Automatic Assembly Tooling

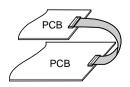
Embossed tape packaging allows for automatic placement onto the PCB.

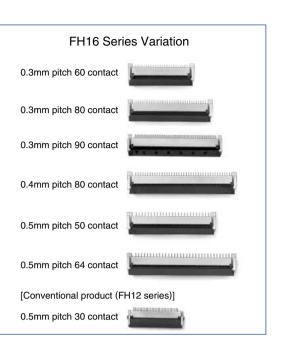
Notebook PC, printers, PDAs, digital cameras and other compact devices for interconnecting the main circuit board with the LCD,PDP(Plasma Display),HDD or other device.



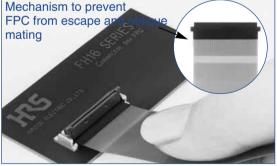












■Product Specifications

		Pitch	0.3mm	0.4mm	0.5mm	Operating Temperature Range: -40°C to +70°C(Note 2)	Storage Temperature Range: -10°C to +50°C(Note 3)
Ra	atings	Current rating(Note 1)	0.15A	0.3A	0.4A	Operating Relative Humidity: Relative humidity 90% max	Storage Relative Humidity: Relative humidity 90% max
		Voltage rating	30V AC	50V AC	60V AC	(not dewed)	(not dewed)

Applicable cable t=0.30 \pm 0.05, gold plated

Item	Specification	Conditions					
1. Insulation resistance	500M ohms min.	100V DC					
2. Withstanding voltage	No flashover or insulation breakdown.	0.3mm pitch: 90V AC 0.4mm pitch: 150V AC /one minute 0.5mm pitch: 200V AC					
3. Contact resistance	150m ohms max. *Including FPC conductor resistance.	1mA					
4. Durability (Insertion/withdrawal)	150m ohms max. No damage, cracks, or parts dislocation.	20 cycles					
5. Vibration	No electrical discontinuity of 1μ s or more Contact resistance: 150m ohms max. No damage, cracks, or parts dislocation.	Frequency: 10 to 55 Hz, single amplitude of 0.75 mm, 2 hours in each of the 3 directions.					
6. Shock	No electrical discontinuity of 1μ s or more Contact resistance: 150m ohms max. No damage, cracks, or parts dislocation.	Acceleration of 490 m/s ² , 11 ms duration, sine half-wave waveform, 3 cycles in each of the 3 axis.					
7. Humidity (Steady state)	Contact resistance: 150m ohms max. Insulation resistance: 50M ohms min. No damage, cracks, or parts dislocation.	96 hours at $40^\circ\!C$ and humidity of 90% to 95%					
8. Temperature cycle	Contact resistance: 150m ohms max. Insulation resistance: 50M ohms min. No damage, cracks, or parts dislocation.	$\begin{array}{ccc} \text{Temperature:} -40^\circ \text{C} & \rightarrow +15 \text{ to } 35^\circ \text{C} & \rightarrow +85^\circ \text{C} & \rightarrow +15^\circ \text{C} \text{ to } 35^\circ \text{C} \\ \text{Time} & : 30 \text{ minutes } \rightarrow 5 \text{ minutes max.} & \rightarrow 30 \text{ minutes } \rightarrow 5 \text{ minutes max.} \\ & 5 \text{ cycles} \end{array}$					
9. Resistance to Soldering heat	No deformation of components affecting performance.	Reflow: At the recommended temperature profile Manual soldering: 350°C for 3 seconds					

Note 1: When passing the current through all of the contacts, use 70% of the current rating.

Note 2: Includes temperature rise caused by current flow.

Note 3: The term "storage" refers to products stored for long period of time prior to mounting and use. Operating Temperature Range and Humidity range covers nonconducting condition of installed connectors in storage, shipment or during transportation.

■Materials

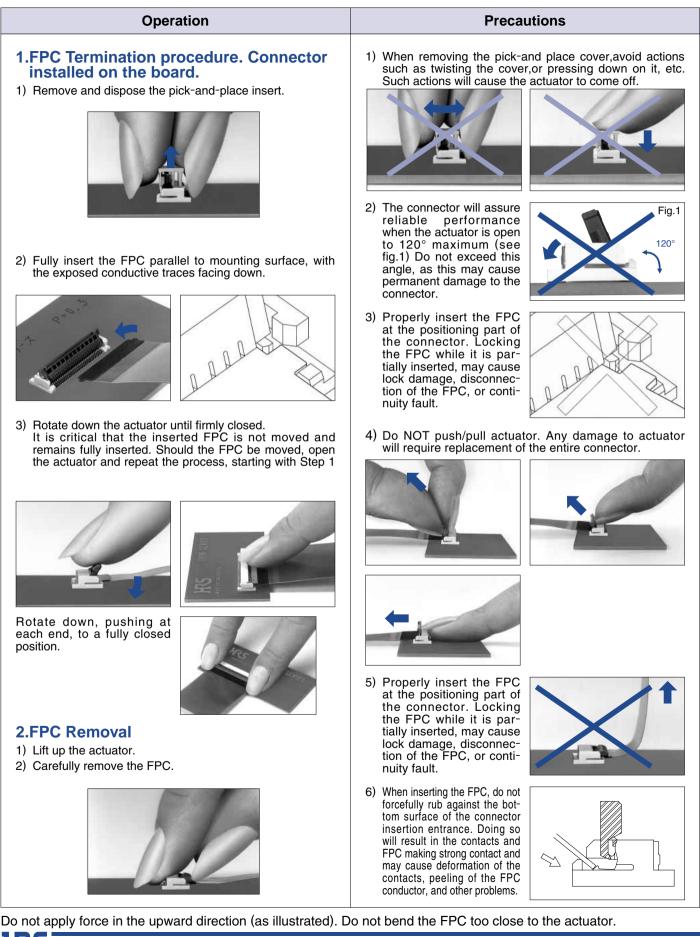
Part	Material	Finish	Remarks	
Inculator	Polyamide		UL94V-0	
Insulator	LCP	Color : Beige		
Actuator	PPS	Color : Dark brown		
Contact	Phosphor bronze	Gold plated		

Ordering Information



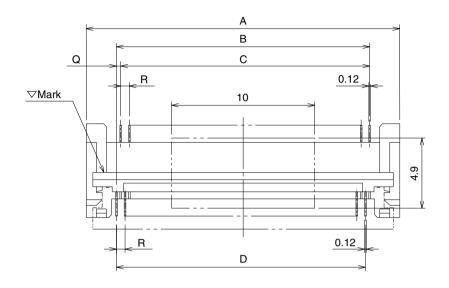
 Series name 	: FH16
2 Number of contacts	5: 50, 60, 64, 80, 90, and 96 contacts
Contact pitch	: 0.3mm, 0.4mm, 0.5mm
4 Terminal Shape	: SHW(SMT horizontal staggered row mount type)
5 Plating Specification	n : (05) : gold flash plated(RoHS compliant)

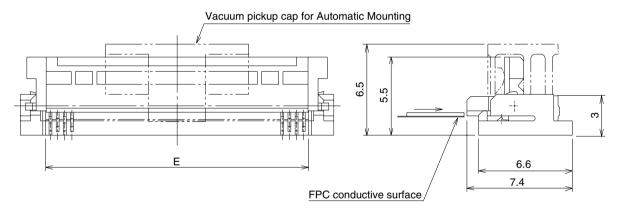
Connector Operating Instructions, precautions and recommendations



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Connector Dimensions



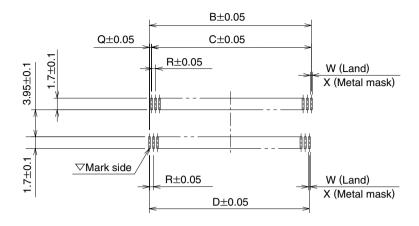


Unit: mm

Part Number	CL No.	Number of contacts	FPC Contact Pitch	А	В	С	D	E	Q	R	RoHS
FH16-60S-0.3SHW(05)	586-0620-2-05	60	0.3	21.9	17.7	17.4	17.4	18.35	0.3	0.6	
FH16-80S-0.3SHW(05)	586-0613-7-05	80	0.3	27.9	23.7	23.4	23.4	24.35	0.3	0.6	
FH16-90S-0.3SHW(05)	586-0697-7-05	90	0.3	30.9	26.7	26.4	26.4	27.35	0.3	0.6	
FH16M-80S-0.4SHW(05)	586-0675-4-05	80	0.4	36.1	31.6	31.2	31.2	32.25	0.4	0.8	YES
FH16M-96S-0.4SHW(05)	586-0715-7-05	96	0.4	42.5	38	37.6	37.6	38.65	0.4	0.8	
FH16H-50S-0.5SHW(05)	586-0676-7-05	50	0.5	29.4	24.5	24	24	25.55	0.5	1	
FH16P-64S-0.5SHW(05)	586-0649-4-05	64	0.5	36	31.5	31	31	32.15	0.5	1	

Note 1: Embossed tape reel packaging (1,000 pieces/reel) Order by number of reels.

Recommended PCB layout and metal mask dimensions



* Recommended metal mask thickness: t=0.15

$0.3^{+0.04}_{-0.03}$ 0.1±0.05 0.07±0.07 Poz No,1 No, (n-1) (0.5) P0,2 1.4±0.1 4MIN 1.3±0.1 1.8±0.1 1.4±0. 2.65±0.2 **3MIN** R0.2 R0.2 T $0.8^{+0.04}_{-0.03}$ No, (n) 2 Q±0.02 0.3±0.05 No,2 $0.3^{+0.04}_{-0.03}$ R±0.02 S±0.07 B±0.03 S±0.07 F±0.05 G±0.1 H±0.1

● FPC recommended dimensions

1 Stiffener material shall be polyimide + thermal hardened additives. 2 Conductor width shall be 0.1 ± 0.05 if FPC has plating bars.

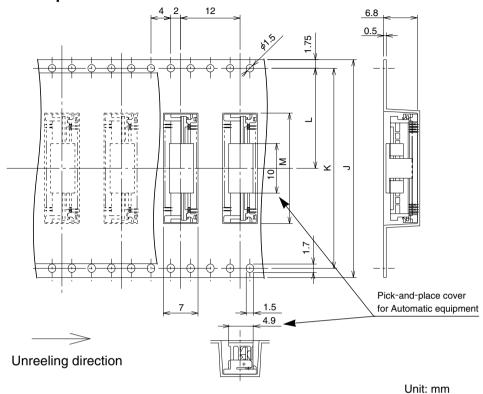
FPC, Land, Metal Mask Dimension

Part Number	CL No.	Number of contacts	FPC Contact Pitch	В	С	D	F	G	Н	Q	R	S	W	Х
FH16-60S-0.3SHW(05)	586-0620-2-05	60	0.3	17.7	17.4	17.4	18.3	18.8	20.3	0.3	0.6	0.3	0.3±0.03	0.25±0.03
FH16-80S-0.3SHW(05)	586-0613-7-05	80	0.3	23.7	23.4	23.4	24.3	24.8	26.3	0.3	0.6	0.3	0.3±0.03	0.25±0.03
FH16-90S-0.3SHW(05)	586-0697-7-05	90	0.3	26.7	26.4	26.4	27.3	27.8	29.3	0.3	0.6	0.3	0.3±0.03	0.25±0.03
FH16M-80S-0.4SHW(05)	586-0675-4-05	80	0.4	31.6	31.2	31.2	32.2	32.7	34.2	0.4	0.8	0.3	0.3±0.03	0.25±0.03
FH16M-96S-0.4SHW(05)	586-0715-7-05	96	0.4	38	37.6	37.6	38.6	39.1	40.6	0.4	0.8	0.3	0.3±0.03	0.25±0.03
FH16H-50S-0.5SHW(05)	586-0676-7-05	50	0.5	24.5	24	24	25.5	25.5	27.5	0.5	1	0.5	0.6±0.1	0.5±0.05
FH16P -64S-0.5SHW(05)	586-0649-4-05	64	0.5	31.5	31	31	32.1	32.6	34.1	0.5	1	0.3	0.6±0.1	0.5±0.05

Unit: mm

Packaging Specification

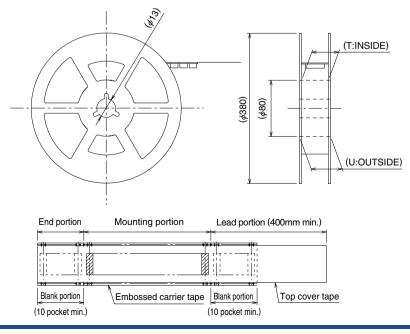
•Embossed Carrier Tape Dimensions



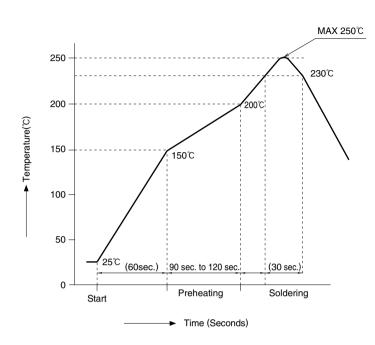
Inserted Connector	Number of Contacts	J	К	L	М	Т	U
FH16-60S-0.3SHW(05)	60	44	40.4	20.2	22.3	45.4	49.4
FH16-80S-0.3SHW(05)	80	44	40.4	20.2	28.3	45.4	49.4
FH16-90S-0.3SHW(05)	90	44	40.4	20.2	31.3	45.4	49.4
FH16M-80S-0.4SHW(05)	80	56	52.4	26.2	36.6	57.4	61.4
FH16M-96S-0.4SHW(05)	96	56	52.4	26.2	43	57.4	61.4
FH16H-50S-0.5SHW(05)	50	44	40.4	20.2	29.9	45.4	49.4
FH16P-64S-0.5SHW(05)	64	56	52.4	26.2	36.6	57.4	61.4

Note: 1,000 pieces per reel.

Reel Dimensions



Recommended Temperature Profile



HRS test conditions Solder method :Reflow,

Solder method	:Reflow, IR/hot air
	(Nihon Den-netsu Co., Ltd.'s Part Number:
	SENSBY NR-II)
Environment	:Room air
Solder composition	:Paste, 96.5%Sn/3.0%Ag/0.5%Cu
	(Senju Metal Industry, Co., Ltd.'s Part
	Number:
	M705-221CM5-42-10.5)
Test board	:Glass epoxy 45mm×80mm×1.6mm thick
Land dimensions	:Contact Pitch 0.3mm, 0.4mm
	0.3mm×1.7mm
	Contact Pitch 0.5mm
	0.6mm×1.7mm
Metal mask	:Contact Pitch 0.3mm, 0.4mm
	0.25mm×1.7mm×0.15mm thick
	Contact Pitch 0.5mm
	0.5mm×1.7mm×0.15mm thick

The temperature profiles shown are based on the above conditions. In individual applications the actual temperature may vary, depending on solder paste type, volume / thickness and board size / thickness. Consult your solder paste and equipment manufacturer for specific recommendations.

● FH16 Series FPC Construction (Recommended Specifications)

h

1. Using Single-Sided FPC	Material Name	Material	Thickness (µm)
	 Covering layer film 	Polyimide 1 mil	25
*****	-Cover adhesive		25
	- Surface treatment	1 to 5 μ m nickel under plated/ 0.2 μ m gold plated	3
	Copper foil	Cu 1oz	35
	Base adhesive		25
<	Base film	Polyimide 1 mil	25
	Reinforcement material adhesive	Heat-hardened adhesive	30
	Stiffener	Polyimide 7 mil	175
		Total	293

2. Comy Double Clack IT C	Material Name	Material	Thickness (µm)
	Covering layer film	Polyimide 1 mil	25
	- Cover adhesive		25
	Surface treatment	1 to 5 μ m nickel plated/ 0.2 μ m gold plated	3
	Through hole copper		15
	Copper foil	Cu 1/2 oz	18
	Base adhesive		18
	Base film	Polyimide 1 mil	25
	Base adhesive		18
	- Copper foil	Cu 1/2 oz	18
	Cover adhesive		25
	Cover layer film	Polyimide 1 mil	25
	Reinforcement material adhesive	Heat-hardened adhesive	50
	Stiffener	Polyimide 1 mil	100
Note : To provent release of the lock due to EPC handing		Total	297

Note : To prevent release of the lock due to FPC bending, please do not use copper foil on the rear side.

2. Using Double-Sided FPC

3. Precautions

1. This specification is a recommendation for the construction of the FH16 Series FPC (t=0.3 \pm 0.05).

2. The FH16 Series are connectors for thin FPC which is beginning to be used in cameras and other miniature equipment. Stiffener is not required for double-sided FPC which will be reflected in FPC cost reduction. Please note that in the case of single-sided FPC, stiffener is required, but the thickness dimension can be created easily. For details about the construction, please contact the FPC manufacturer.